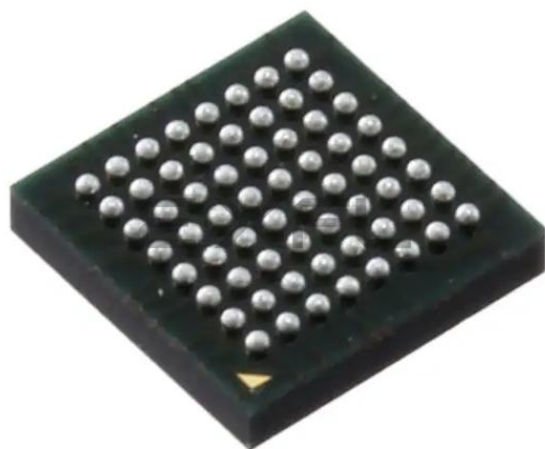




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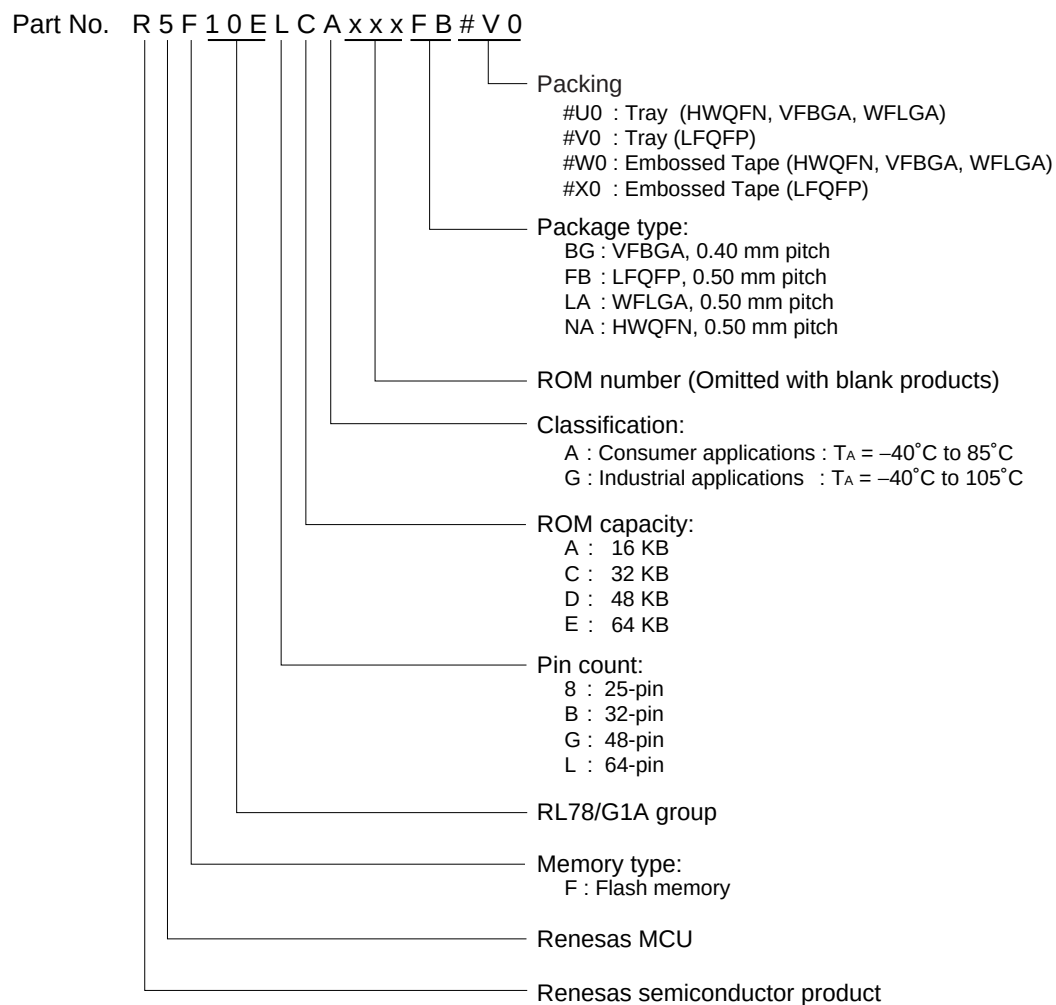
Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I ² C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	46
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 3.6V
Data Converters	A/D 28x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFBGA
Supplier Device Package	64-VFBGA (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10elcabg-u0

1.2 List of Part Numbers

Figure 1-1. Part Number, Memory Size, and Package of RL78/G1A

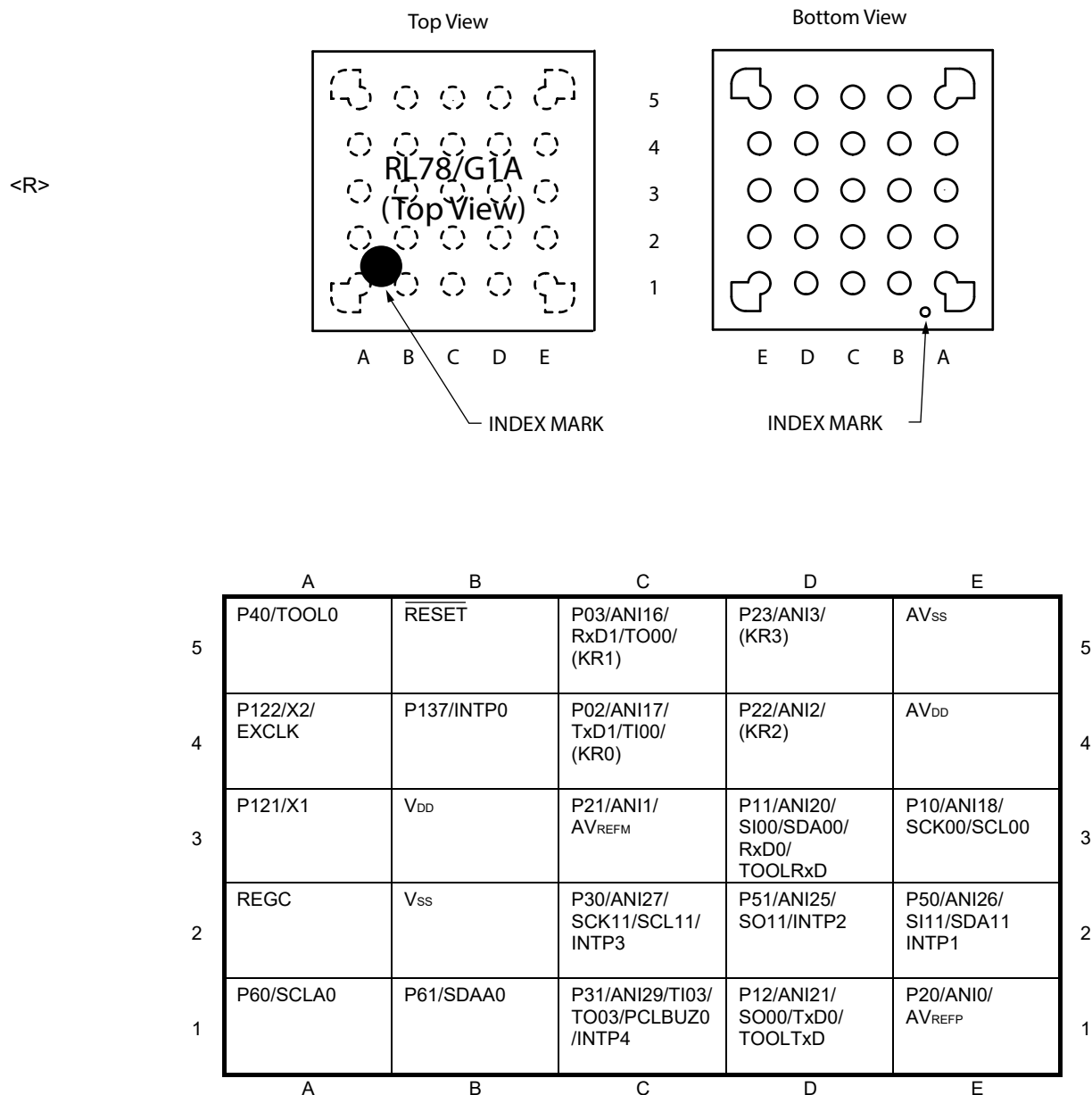


Caution The part number above is valid as of when this manual was issued. For the latest part number, see the web page of the target product on the Renesas Electronics website.

1.3 Pin Configuration (Top View)

1.3.1 25-pin products

- 25-pin plastic WFLGA (3 × 3 mm, 0.50 mm pitch)

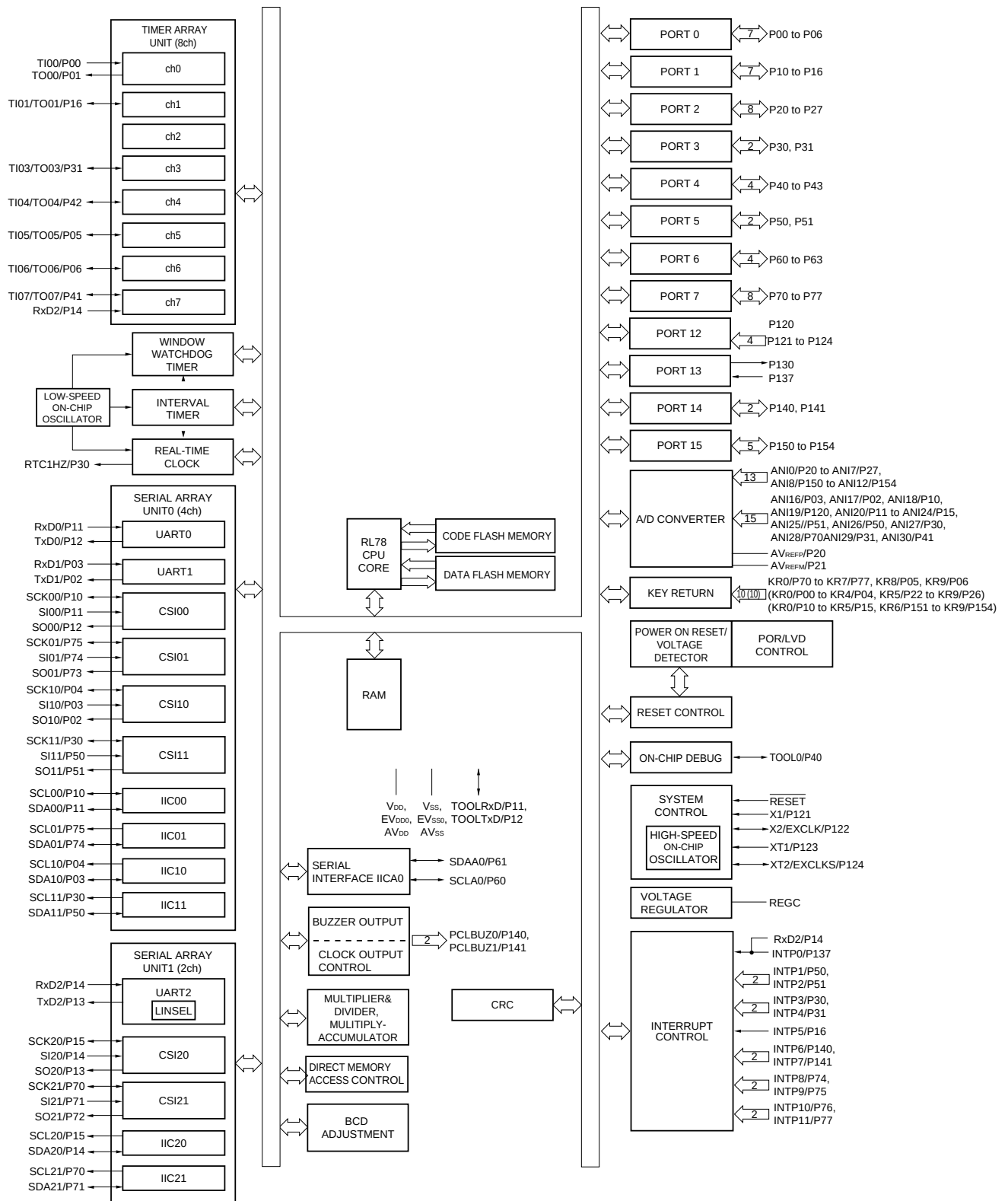


Caution Connect the REGC pin to V_{SS} via a capacitor (0.47 to 1 μF).

Remarks 1. For pin identification, see 1.4 Pin Identification.

- Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR).

1.5.4 64-pin products



Remark Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR).

- Notes**
1. Total current flowing into V_{DD} and EV_{DD0} , including the input leakage current flowing when the level of the input pin is fixed to V_{DD} , EV_{DD0} or V_{SS} , EV_{SS0} . The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, on-chip pull-up/pull-down resistors, and data flash rewriting.
 2. During HALT instruction execution by flash memory.
 3. When high-speed on-chip oscillator and subsystem clock are stopped.
 4. When high-speed system clock and subsystem clock are stopped.
 5. When high-speed on-chip oscillator and high-speed system clock are stopped. When $RTCLPC = 1$ and setting ultra-low current consumption ($AMPHS1 = 1$). Including the current flowing into the RTC. However, not including the current flowing into the 12-bit interval timer, and watchdog timer.
 6. When subsystem clock is stopped. Not including the current flowing into the RTC, 12-bit interval timer, watchdog timer.
 7. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
 - HS (high-speed main) mode: $2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}@1\text{ MHz to }32\text{ MHz}$
 $2.4\text{ V} \leq V_{DD} \leq 3.6\text{ V}@1\text{ MHz to }16\text{ MHz}$
 - LS (low-speed main) mode: $1.8\text{ V} \leq V_{DD} < 3.6\text{ V}@1\text{ MHz to }8\text{ MHz}$
 - LV (low-voltage main) mode: $1.6\text{ V} \leq V_{DD} \leq 3.6\text{ V}@1\text{ MHz to }4\text{ MHz}$
 8. Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.

- Remarks**
1. f_{MX} : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
 2. f_{IH} : High-speed on-chip oscillator clock frequency
 3. f_{SUB} : Subsystem clock frequency (XT1 clock oscillation frequency)
 4. Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is $T_A = 25^\circ\text{C}$

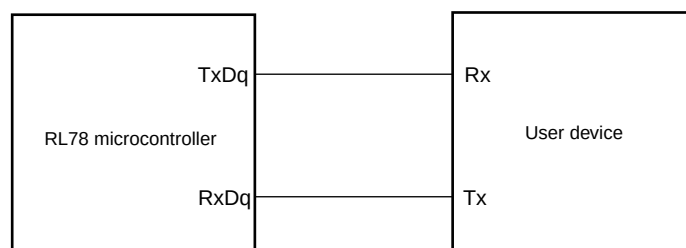
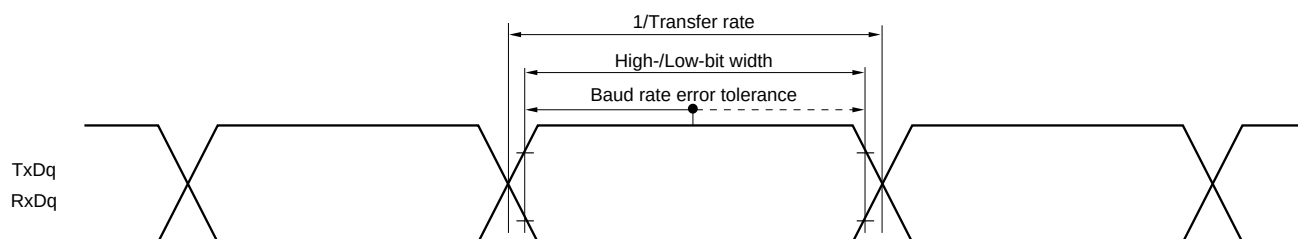
<R>

(T_A = -40 to +85°C, 1.6 V ≤ V_{DD0} ≤ V_{DD} ≤ 3.6 V, V_{SS} = EV_{SS0} = 0 V)

(3/3)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Low-speed on-chip oscillator operating current	I _{FIL} ^{Note 1}				0.20		μA
RTC operating current	I _{RTC} ^{Notes 1, 2, 3}				0.02		μA
12-bit interval timer operating current	I _{IT} ^{Notes 1, 2, 4}				0.02		μA
Watchdog timer operating current	I _{WDT} ^{Notes 1, 2, 5}	f _{IL} = 15 kHz			0.22		μA
A/D converter operating current	I _{ADC} ^{Notes 6, 7}	AV _{DD} = 3.0 V, When conversion at maximum speed			420	720	μA
AV _{REF(+)} current	I _{AVREF} ^{Note 8}	AV _{DD} = 3.0 V, ADREFP1 = 0, ADREFP0 = 0 ^{Note 7}			14.0	25.0	μA
		AV _{REFP} = 3.0 V, ADREFP1 = 0, ADREFP0 = 1 ^{Note 10}			14.0	25.0	μA
		ADREFP1 = 1, ADREFP0 = 0 ^{Note 1}			14.0	25.0	μA
A/D converter reference voltage current	I _{ADREF} ^{Notes 1, 9}	V _{DD} = 3.0 V			75.0		μA
Temperature sensor operating current	I _{TMP} ^{Note 1}	V _{DD} = 3.0 V			75.0		μA
LVD operating current	I _{LVD} ^{Notes 1, 11}				0.08		μA
BGO operating current	I _{BGO} ^{Notes 1, 12}				2.5	12.2	mA
Self-programming operating current	I _{FSP} ^{Notes 1, 13}				2.5	12.2	mA
SNOOZE operating current	I _{SNOZ}	A/D converter operation (AV _{DD} = 3.0 V)	The mode is performed ^{Notes 1, 14}		0.50	0.60	mA
			During A/D conversion ^{Note 1}		0.60	0.75	mA
			During A/D conversion ^{Note 7}		420	720	μA
		CSI/UART operation ^{Note 1}			0.70	0.84	mA

(Notes and Remarks are listed on the next page.)

UART mode connection diagram (during communication at same potential)**UART mode bit width (during communication at same potential) (reference)**

- Remarks**
1. q: UART number ($q = 0$ to 2), g: PIM and POM number ($g = 0, 1$)
 2. f_{MCK} : Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number ($mn = 00$ to $03, 10, 11$))

(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)

(T_A = -40 to +85°C, 2.7 V ≤ EV_{DD0} ≤ V_{DD} ≤ 3.6 V, V_{SS} = EV_{SS0} = 0 V)

Parameter	Symbol	Conditions	HS ^{Note 1}		LS ^{Note 2}		LV ^{Note 3}		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	t _{KCY1}	2.7 V ≤ EV _{DD} ≤ 3.6 V, t _{KCY1} ≥ 2/f _{CLK}	83.3		250		500		ns
SCKp high-/low-level width	t _{KH1} , t _{KL1}	2.7 V ≤ EV _{DD} ≤ 3.6 V	t _{KCY1} /2 -10		t _{KCY1} /2 -50		t _{KCY1} /2 -50		ns
Slp setup time (to SCKp↑) ^{Note 4}	t _{SIK1}	2.7 V ≤ EV _{DD} ≤ 3.6 V	33		110		110		ns
Slp hold time (from SCKp↑) ^{Note 4}	t _{KSI1}	2.7 V ≤ EV _{DD} ≤ 3.6 V	10		10		10		ns
Delay time from SCKp↓ to SOp output ^{Note 5}	t _{KSO1}	C = 20 pF ^{Note 6}		10		10		10	ns

Notes 1. HS is condition of HS (high-speed main) mode.

2. LS is condition of LS (low-speed main) mode.

3. LV is condition of LV (low-voltage main) mode.

4. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The Slp setup time or Slp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

5. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

6. C is the load capacitance of the SCKp and SOp output lines.

Caution Select the normal input buffer for the SIp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

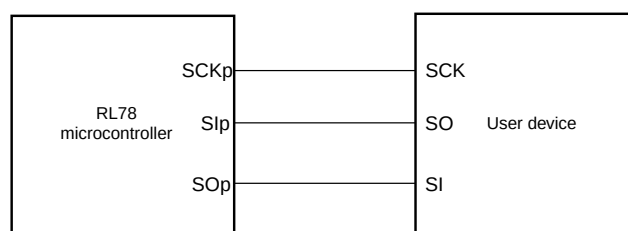
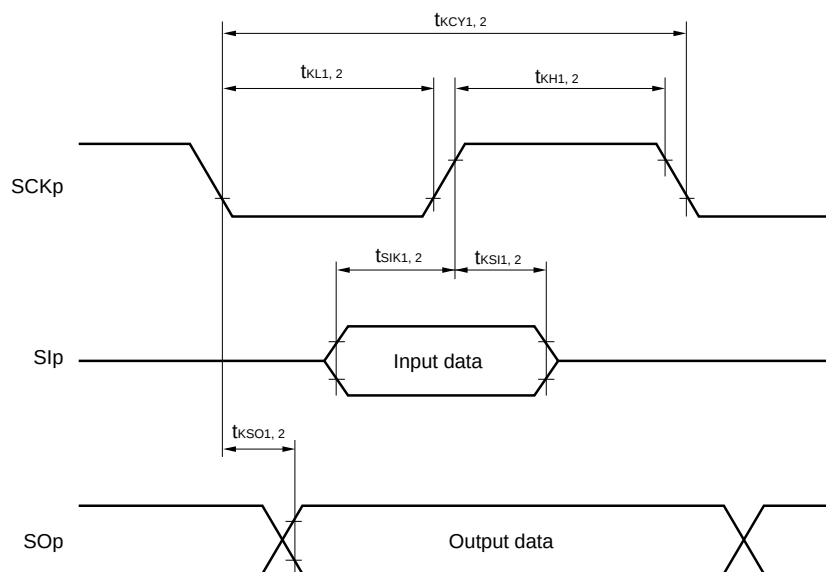
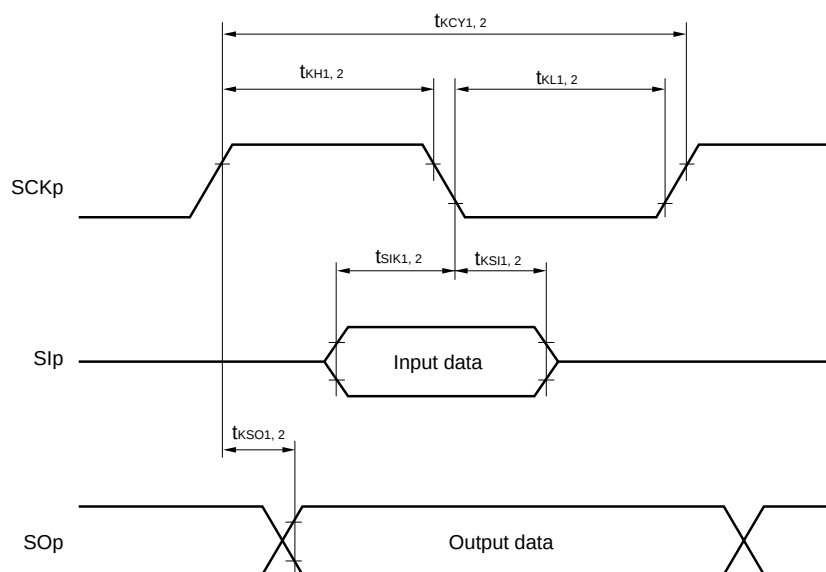
Remarks 1. p: CSI number (p = 00), m: Unit number (m = 0), n: Channel number (n = 0),
g: PIM and POM numbers (g = 1)

2. f_{MCK}: Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number,
n: Channel number (mn = 00))

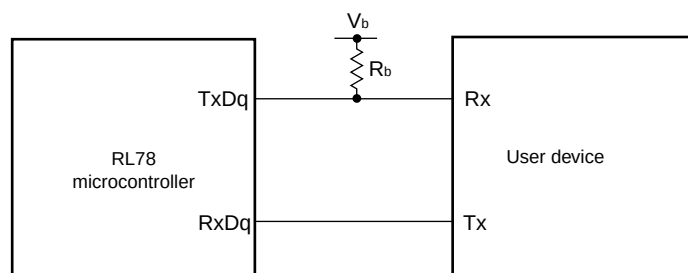
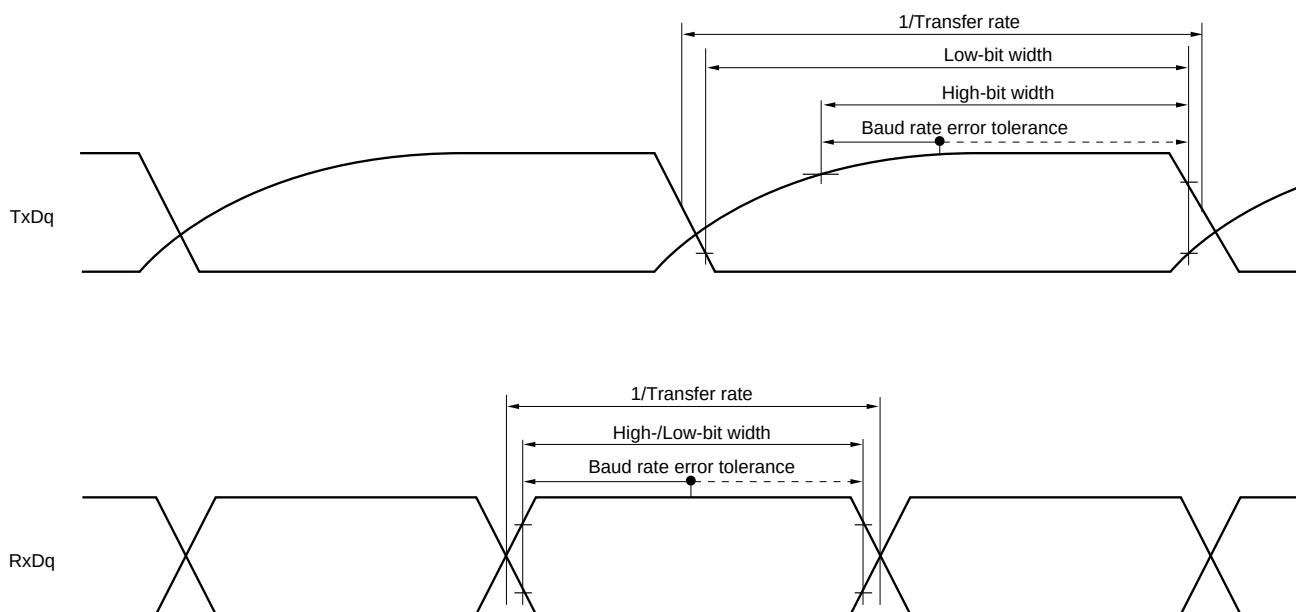
- Notes**
1. HS is condition of HS (high-speed main) mode.
 2. LS is condition of LS (low-speed main) mode.
 3. LV is condition of LV (low-voltage main) mode.
 4. Transfer rate in the SNOOZE mode: MAX. 1 Mbps
 5. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time or SIp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
 6. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.
 7. C is the load capacitance of the SOp output lines.

Caution Select the normal input buffer for the SIp pin and SCKp pin and the normal output mode for the SOp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

- Remarks**
1. p: CSI number (p = 00, 01, 10, 11, 20, 21), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3),
g: PIM number (g = 0, 1)
 2. f_{MCK}: Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number,
n: Channel number (mn = 00 to 03, 10, 11))

CSI mode connection diagram (during communication at same potential)**CSI mode serial transfer timing (during communication at same potential)**(When $\text{DAPmn} = 0$ and $\text{CKPmn} = 0$, or $\text{DAPmn} = 1$ and $\text{CKPmn} = 1$.)**CSI mode serial transfer timing (during communication at same potential)**(When $\text{DAPmn} = 0$ and $\text{CKPmn} = 1$, or $\text{DAPmn} = 1$ and $\text{CKPmn} = 0$.)

- Remarks**
1. p: CSI number (p = 00, 01, 10, 11, 20, 21)
 2. m: Unit number, n: Channel number (mn = 00 to 03, 10, 11)

UART mode connection diagram (during communication at different potential)**UART mode bit width (during communication at different potential) (reference)**

- Remarks**
1. $R_b[\Omega]$: Communication line (TxDq) pull-up resistance,
 $C_b[\text{F}]$: Communication line (TxDq) load capacitance, $V_b[\text{V}]$: Communication line voltage
 2. q: UART number (q = 0 to 2), g: PIM and POM number (g = 0, 1)
 3. f_{MCK} : Serial array unit operation clock frequency
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
 m: Unit number, n: Channel number (mn = 00 to 03, 10, 11))

<R> (4) When reference voltage (+) = AV_{REFP}/ANI0 (ADREFP1 = 0, ADREFP0 = 1), reference voltage (-) = AV_{REFM}/ANI1 (ADREFM = 1), target for conversion: ANI16 to ANI30, internal reference voltage, temperature sensor output voltage

(T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} ≤ V_{DD} ≤ 3.6 V, 1.6 V ≤ AV_{REFP} ≤ AV_{DD} ≤ V_{DD} ≤ 3.6 V, V_{SS} = EV_{SS0} = 0 V, AV_{SS} = 0 V, Reference voltage (+) = AV_{REFP}, Reference voltage (-) = AV_{REFM} = 0 V)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Resolution	R _{ES}		2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	8		12	bit
			1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	8		10 ^{Note 1}	
			1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	8 ^{Note 2}			
Overall error ^{Note 3}	A _{INL}	12-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±7.0	LSB
		10-bit resolution	1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±5.5	
		8-bit resolution	1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±3.0	
Conversion time	t _{CONV}	ADTYP = 0, 12-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	4.125			μs
		ADTYP = 0, 10-bit resolution ^{Note 1}	1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	9.5			
		ADTYP = 0, 8-bit resolution ^{Note 2}	1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	57.5			
		ADTYP = 1, 8-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	3.3125			
			1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	7.875			
			1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V	54.25			
Zero-scale error ^{Note 3}	E _{ZS}	12-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±5.0	LSB
		10-bit resolution	1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±5.0	
		8-bit resolution	1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±2.5	
Full-scale error ^{Note 3}	E _{FS}	12-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±5.0	LSB
		10-bit resolution	1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±5.0	
		8-bit resolution	1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±2.5	
Integral linearity error ^{Note 3}	I _{LE}	12-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±3.0	LSB
		10-bit resolution	1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±2.0	
		8-bit resolution	1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±1.5	
Differential linearity error ^{Note 3}	D _{LE}	12-bit resolution	2.4 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±2.0	LSB
		10-bit resolution	1.8 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±2.0	
		8-bit resolution	1.6 V ≤ AV _{REFP} ≤ AV _{DD} ≤ 3.6 V			±1.5	
Analog input voltage	V _{AIN}			0		AV _{REFP} and EV _{DD0}	V
		Interanal reference voltage (2.4 V ≤ V _{DD} ≤ 3.6 V, HS (high-speed main) mode)		V _{BGR} ^{Note 4}			V
		Temperature sensor output voltage (2.4 V ≤ V _{DD} ≤ 3.6 V, HS (high-speed main) mode)		V _{TMPS25} ^{Note 4}			V

- Notes 1.** Cannot be used for lower 2 bit of ADCR register
2. Cannot be used for lower 4 bit of ADCR register
3. Excludes quantization error (±1/2 LSB).
4. See 2.6.2 Temperature sensor, internal reference voltage output characteristics.

2.6.4 LVD circuit characteristics

LVD Detection Voltage of Reset Mode and Interrupt Mode**($T_A = -40$ to $+85^\circ\text{C}$, $V_{PDR} \leq V_{DD} \leq 3.6\text{ V}$, $V_{SS} = 0\text{ V}$)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	Supply voltage level	V _{LVD2}	Power supply rise time	3.07	3.13	3.19	V
			Power supply fall time	3.00	3.06	3.12	V
		V _{LVD3}	Power supply rise time	2.96	3.02	3.08	V
			Power supply fall time	2.90	2.96	3.02	V
		V _{LVD4}	Power supply rise time	2.86	2.92	2.97	V
			Power supply fall time	2.80	2.86	2.91	V
		V _{LVD5}	Power supply rise time	2.76	2.81	2.87	V
			Power supply fall time	2.70	2.75	2.81	V
		V _{LVD6}	Power supply rise time	2.66	2.71	2.76	V
			Power supply fall time	2.60	2.65	2.70	V
		V _{LVD7}	Power supply rise time	2.56	2.61	2.66	V
			Power supply fall time	2.50	2.55	2.60	V
		V _{LVD8}	Power supply rise time	2.45	2.50	2.55	V
			Power supply fall time	2.40	2.45	2.50	V
		V _{LVD9}	Power supply rise time	2.05	2.09	2.13	V
			Power supply fall time	2.00	2.04	2.08	V
		V _{LVD10}	Power supply rise time	1.94	1.98	2.02	V
			Power supply fall time	1.90	1.94	1.98	V
		V _{LVD11}	Power supply rise time	1.84	1.88	1.91	V
			Power supply fall time	1.80	1.84	1.87	V
		V _{LVD12}	Power supply rise time	1.74	1.77	1.81	V
			Power supply fall time	1.70	1.73	1.77	V
		V _{LVD13}	Power supply rise time	1.64	1.67	1.70	V
			Power supply fall time	1.60	1.63	1.66	V
Minimum pulse width		t _{LW}		300			μs
Detection delay time						300	μs

Caution Set the detection voltage (V_{LVD}) to be within the operating voltage range. The operating voltage range depends on the setting of the user option byte (000C2H/010C2H). The following shows the operating voltage range.

HS (high-speed main) mode: $V_{DD} = 2.7$ to $3.6\text{ V}@1\text{ MHz to }32\text{ MHz}$

$V_{DD} = 2.4$ to $3.6\text{ V}@1\text{ MHz to }16\text{ MHz}$

LS (low-speed main) mode: $V_{DD} = 1.8$ to $3.6\text{ V}@1\text{ MHz to }8\text{ MHz}$

LV (low-voltage main) mode: $V_{DD} = 1.6$ to $3.6\text{ V}@1\text{ MHz to }4\text{ MHz}$

LVD Detection Voltage of Interrupt & Reset Mode(T_A = -40 to +85°C, V_{PDR} ≤ V_{DD} ≤ 3.6 V, V_{SS} = 0 V)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Interrupt & reset mode	V _{LVD13}	VPOC2, VPOC1, VPOC0 = 0, 0, 0, falling reset voltage		1.60	1.63	1.66	V
	V _{LVD12}	LVIS1, LVIS0 = 1, 0	Rising release reset voltage	1.74	1.77	1.81	V
			Falling interrupt voltage	1.70	1.73	1.77	V
	V _{LVD11}	LVIS1, LVIS0 = 0, 1	Rising release reset voltage	1.84	1.88	1.91	V
			Falling interrupt voltage	1.80	1.84	1.87	V
	V _{LVD4}	LVIS1, LVIS0 = 0, 0	Rising release reset voltage	2.86	2.92	2.97	V
			Falling interrupt voltage	2.80	2.86	2.91	V
	V _{LVD11}	VPOC2, VPOC1, VPOC0 = 0, 0, 1, falling reset voltage		1.80	1.84	1.87	V
	V _{LVD10}	LVIS1, LVIS0 = 1, 0	Rising release reset voltage	1.94	1.98	2.02	V
			Falling interrupt voltage	1.90	1.94	1.98	V
	V _{LVD9}	LVIS1, LVIS0 = 0, 1	Rising release reset voltage	2.05	2.09	2.13	V
			Falling interrupt voltage	2.00	2.04	2.08	V
	V _{LVD2}	LVIS1, LVIS0 = 0, 0	Rising release reset voltage	3.07	3.13	3.19	V
			Falling interrupt voltage	3.00	3.06	3.12	V
	V _{LVD8}	VPOC2, VPOC1, VPOC0 = 0, 1, 0, falling reset voltage		2.40	2.45	2.50	V
	V _{LVD7}	LVIS1, LVIS0 = 1, 0	Rising release reset voltage	2.56	2.61	2.66	V
			Falling interrupt voltage	2.50	2.55	2.60	V
	V _{LVD6}	LVIS1, LVIS0 = 0, 1	Rising release reset voltage	2.66	2.71	2.76	V
			Falling interrupt voltage	2.60	2.65	2.70	V
	V _{LVD5}	VPOC2, VPOC1, VPOC0 = 0, 1, 1, falling reset voltage		2.70	2.75	2.81	V
	V _{LVD4}	LVIS1, LVIS0 = 1, 0	Rising release reset voltage	2.86	2.92	2.97	V
			Falling interrupt voltage	2.80	2.86	2.91	V
	V _{LVD3}	LVIS1, LVIS0 = 0, 1	Rising release reset voltage	2.96	3.02	3.08	V
			Falling interrupt voltage	2.90	2.96	3.02	V

Caution Set the detection voltage (V_{LVD}) to be within the operating voltage range. The operating voltage range depends on the setting of the user option byte (000C2H/010C2H). The following shows the operating voltage range.

HS (high-speed main) mode: V_{DD} = 2.7 to 3.6 V@1 MHz to 32 MHz

V_{DD} = 2.4 to 3.6 V@1 MHz to 16 MHz

LS (low-speed main) mode: V_{DD} = 1.8 to 3.6 V@1 MHz to 8 MHz

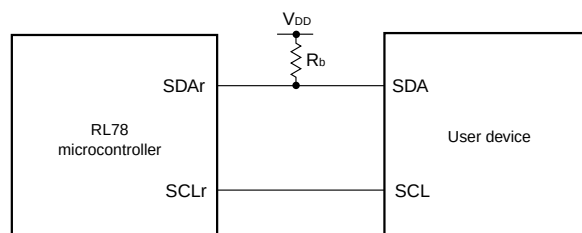
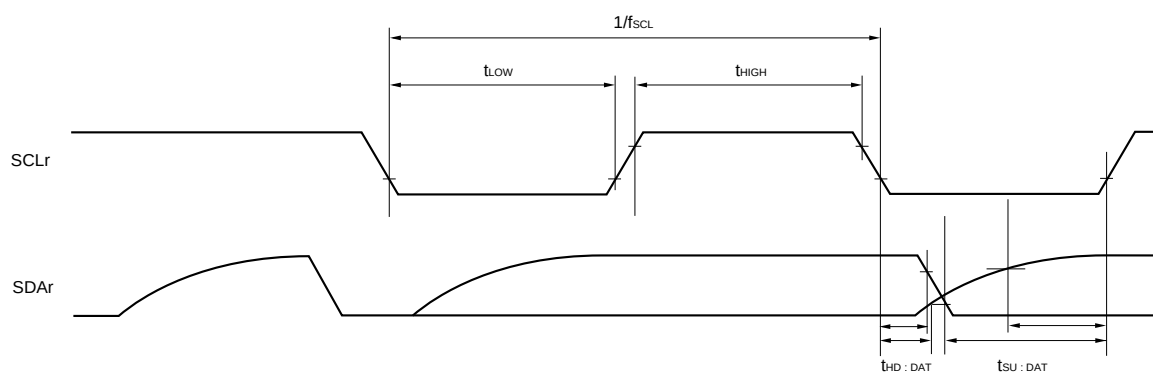
LV (low-voltage main) mode: V_{DD} = 1.6 to 3.6 V@1 MHz to 4 MHz

2.6.5 Supply voltage rise slope characteristics

(T_A = -40 to +85°C, V_{SS} = 0 V)

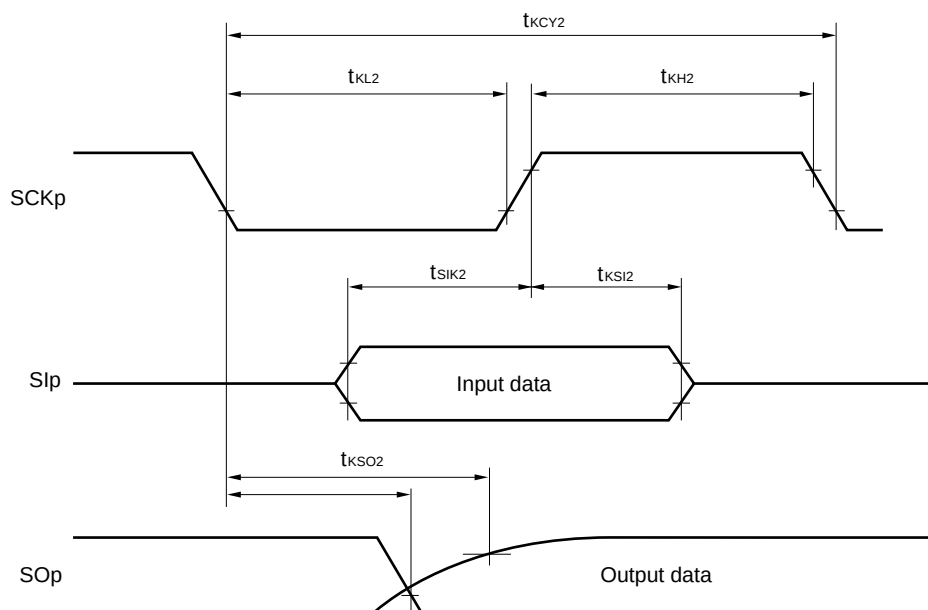
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Supply voltage rise	SV _{DD}				54	V/ms

Caution Be sure to maintain the internal reset state until V_{DD} reaches the operating voltage range specified in 2.4 AC Characteristics, by using the LVD circuit or external reset pin.

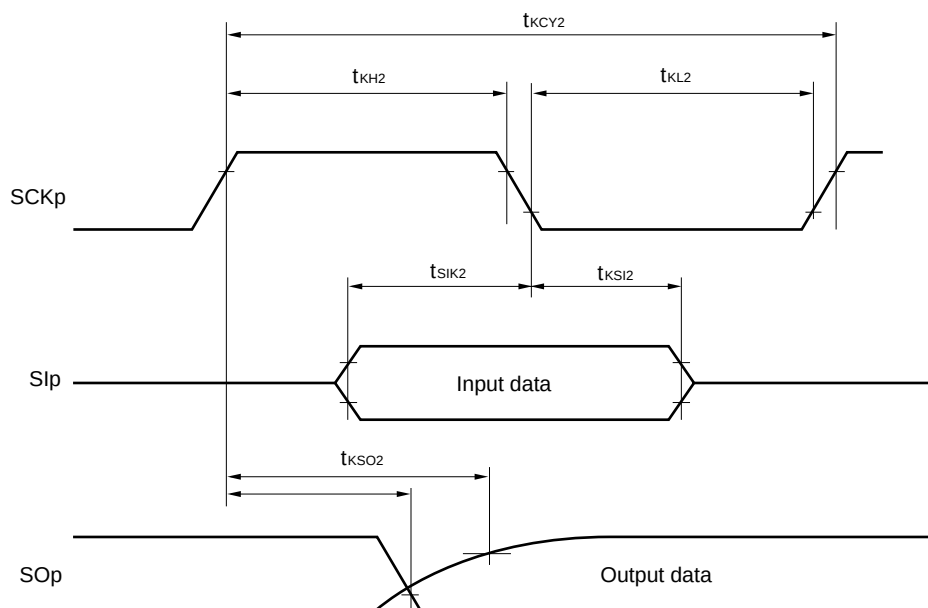
Simplified I²C mode connection diagram (during communication at same potential)**Simplified I²C mode serial transfer timing (during communication at same potential)**

- Remarks**
1. $R_b[\Omega]$: Communication line (SDAr) pull-up resistance, $C_b[F]$: Communication line (SDAr, SCLr) load capacitance
 2. r: IIC number (r = 00, 01, 10, 11, 20, 21), g: PIM number (g = 0, 1), h: POM number (h = 0, 1)
 3. f_{MCK} : Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number, mn = 00 to 03, 10, 11)

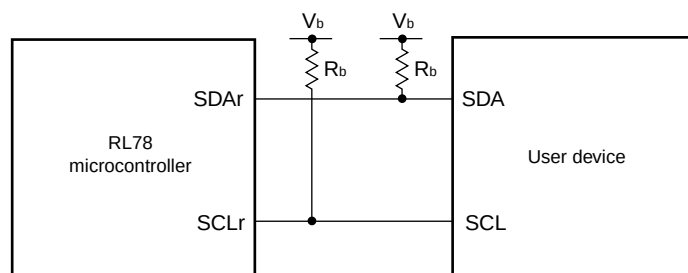
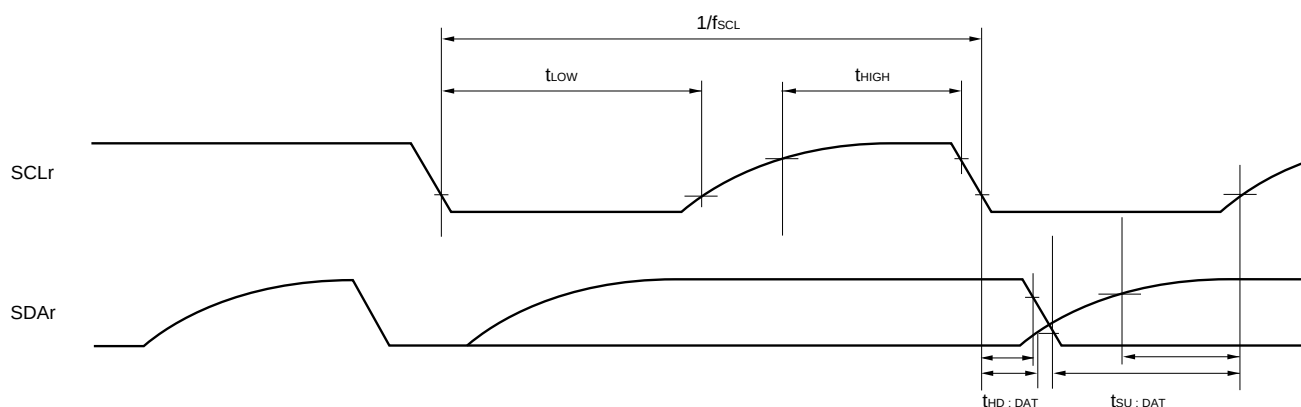
CSI mode serial transfer timing (slave mode) (during communication at different potential)
(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)



CSI mode serial transfer timing (slave mode) (during communication at different potential)
(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)



- Remarks 1.** p: CSI number (p = 00, 10, 20), m: Unit number, n: Channel number (mn = 00, 02, 10), g: PIM and POM number (g = 0, 1)
- 2.** CSI01, CSI11, and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.

Simplified I²C mode connection diagram (during communication at different potential)**Simplified I²C mode serial transfer timing (during communication at different potential)**

- Remarks**
1. $R_b[\Omega]$: Communication line (SDAr, SCLr) pull-up resistance, $C_b[F]$: Communication line (SDAr, SCLr) load capacitance, $V_b[V]$: Communication line voltage
 2. r: IIC number (r = 00, 10, 20), g: PIM, POM number (g = 0, 1)
 3. f_{MCK} : Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00, 02, 10))
 4. IIC01, IIC11, and IIC21 cannot communicate at different potential. Use IIC00, IIC10, or IIC20 for communication at different potential.

3.6.4 LVD circuit characteristics

LVD Detection Voltage of Reset Mode and Interrupt Mode**($T_A = -40$ to $+105^\circ\text{C}$, $V_{PDR} \leq V_{DD} \leq 3.6\text{ V}$, $V_{SS} = 0\text{ V}$)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	Supply voltage level	V _{LVD2}	Power supply rise time	3.01	3.13	3.25	V
			Power supply fall time	2.94	3.06	3.18	V
		V _{LVD3}	Power supply rise time	2.90	3.02	3.14	V
			Power supply fall time	2.85	2.96	3.07	V
		V _{LVD4}	Power supply rise time	2.81	2.92	3.03	V
			Power supply fall time	2.75	2.86	2.97	V
		V _{LVD5}	Power supply rise time	2.70	2.81	2.92	V
			Power supply fall time	2.64	2.75	2.86	V
		V _{LVD6}	Power supply rise time	2.61	2.71	2.81	V
			Power supply fall time	2.55	2.65	2.75	V
		V _{LVD7}	Power supply rise time	2.51	2.61	2.71	V
			Power supply fall time	2.45	2.55	2.65	V
Minimum pulse width		t _{LW}		300			μs
Detection delay time						300	μs

Remark $V_{LVD(n-1)} > V_{LVDn}$: $n = 3$ to 7 **LVD Detection Voltage of Interrupt & Reset Mode****($T_A = -40$ to $+105^\circ\text{C}$, $V_{PDR} \leq V_{DD} \leq 3.6\text{ V}$, $V_{SS} = 0\text{ V}$)**

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Interrupt & reset mode	V _{LVD5}	VPOC2, VPOC1, VPOC0 = 0, 1, 1, falling reset voltage		2.64	2.75	2.86	V
	V _{LVD4}	LVIS1, LVIS0 = 1, 0	Rising release reset voltage	2.81	2.92	3.03	V
			Falling interrupt voltage	2.75	2.86	2.97	V
	V _{LVD3}	LVIS1, LVIS0 = 0, 1	Rising release reset voltage	2.90	3.02	3.14	V
			Falling interrupt voltage	2.85	2.96	3.07	V

Caution Set the detection voltage (V_{LVD}) to be within the operating voltage range. The operating voltage range depends on the setting of the user option byte (000C2H/010C2H). The following shows the operating voltage range.

HS (high-speed main) mode: $V_{DD} = 2.7$ to $3.6\text{ V}@1\text{ MHz to }32\text{ MHz}$

$V_{DD} = 2.4$ to $3.6\text{ V}@1\text{ MHz to }16\text{ MHz}$

3.6.5 Supply voltage rise slope characteristics

($T_A = -40$ to $+105^\circ\text{C}$, $V_{SS} = 0\text{ V}$)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Supply voltage rise	SV_{DD}				54	V/ms

Caution Be sure to maintain the internal reset state until V_{DD} reaches the operating voltage range specified in 3.4 AC Characteristics, by using the LVD circuit or external reset pin.

4. PACKAGE DRAWINGS

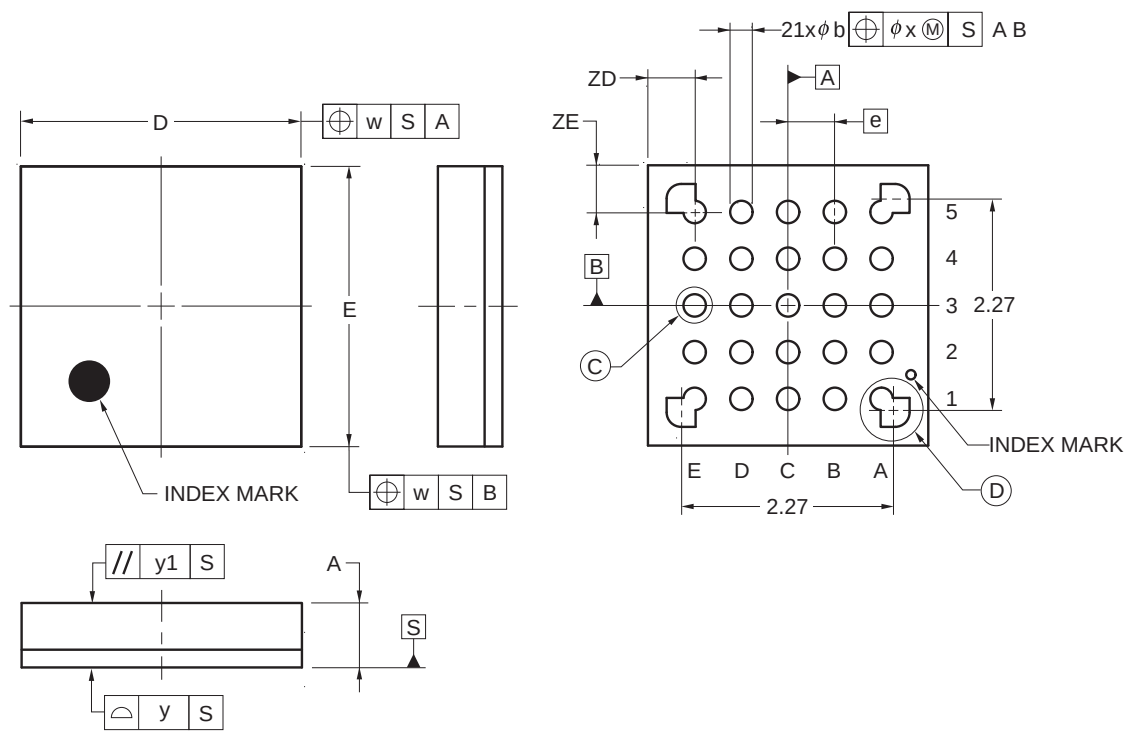
4.1 25-pin products

R5F10E8AALA, R5F10E8CALA, R5F10E8DALA, R5F10E8EALA

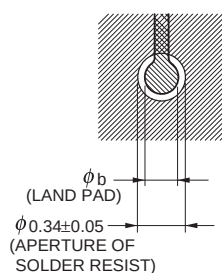
<R>

JEITA Package Code	RENESAS Code	Previous Code	MASS (Typ) [g]
P-WFLGA25-3x3-0.50	PWLG0025KA-A	P25FC-50-2N2-3	0.01

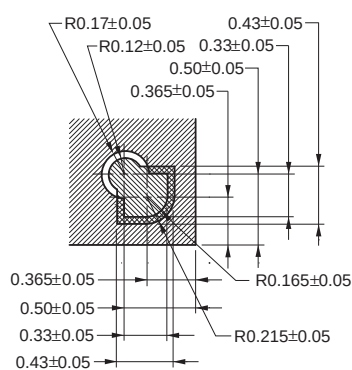
Unit: mm



DETAIL OF ③ PART



DETAIL OF ④ PART



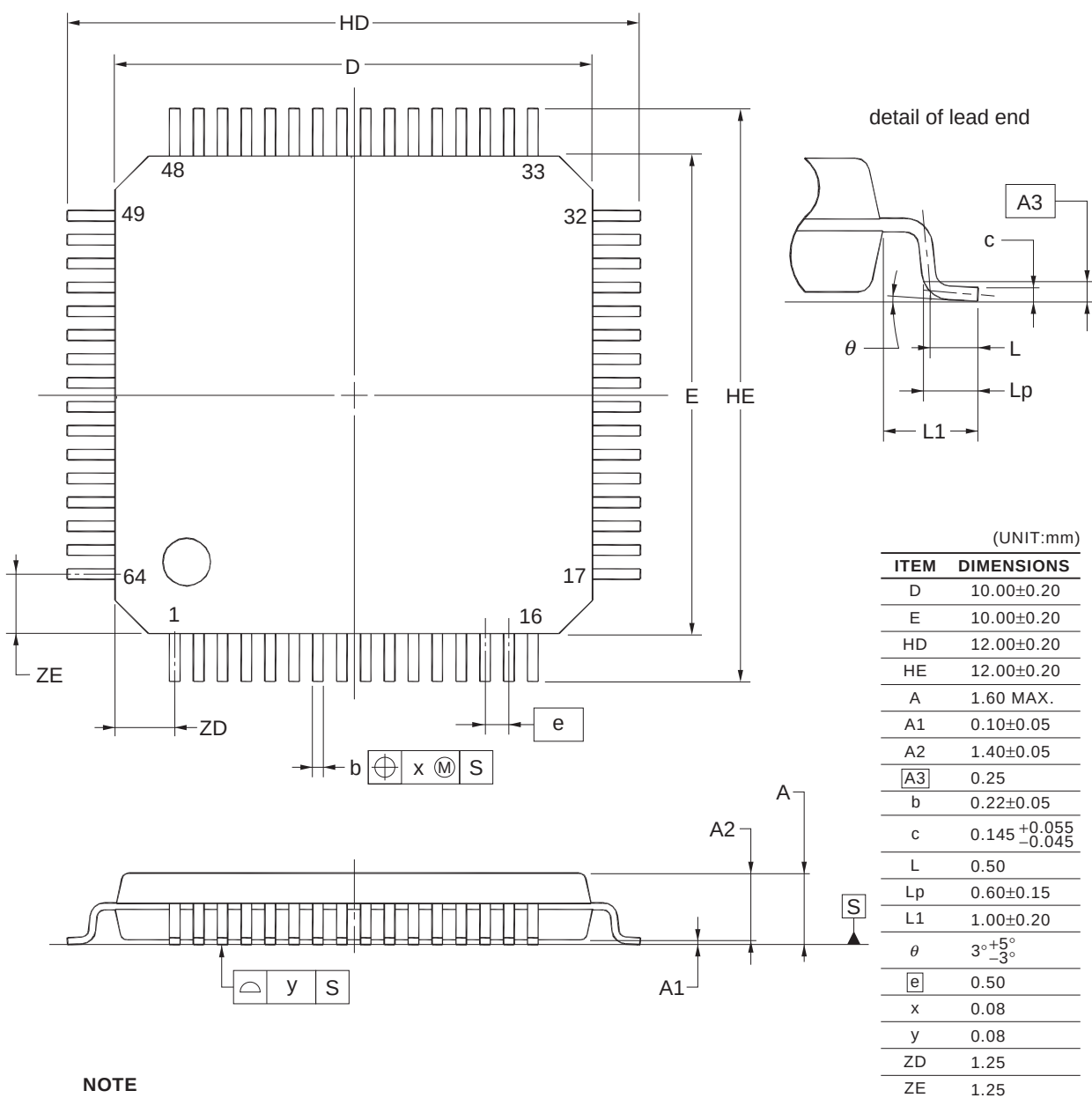
ITEM	DIMENSIONS
D	3.00±0.10
E	3.00±0.10
w	0.20
e	0.50
A	0.69±0.07
b	0.24±0.05
x	0.05
y	0.08
y1	0.20
ZD	0.50
ZE	0.50

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4.4 64-pin products

R5F10ELCAFB, R5F10ELDAFB, R5F10ELEAFB
R5F10ELCGFB, R5F10ELDGFB, R5F10ELEGFB

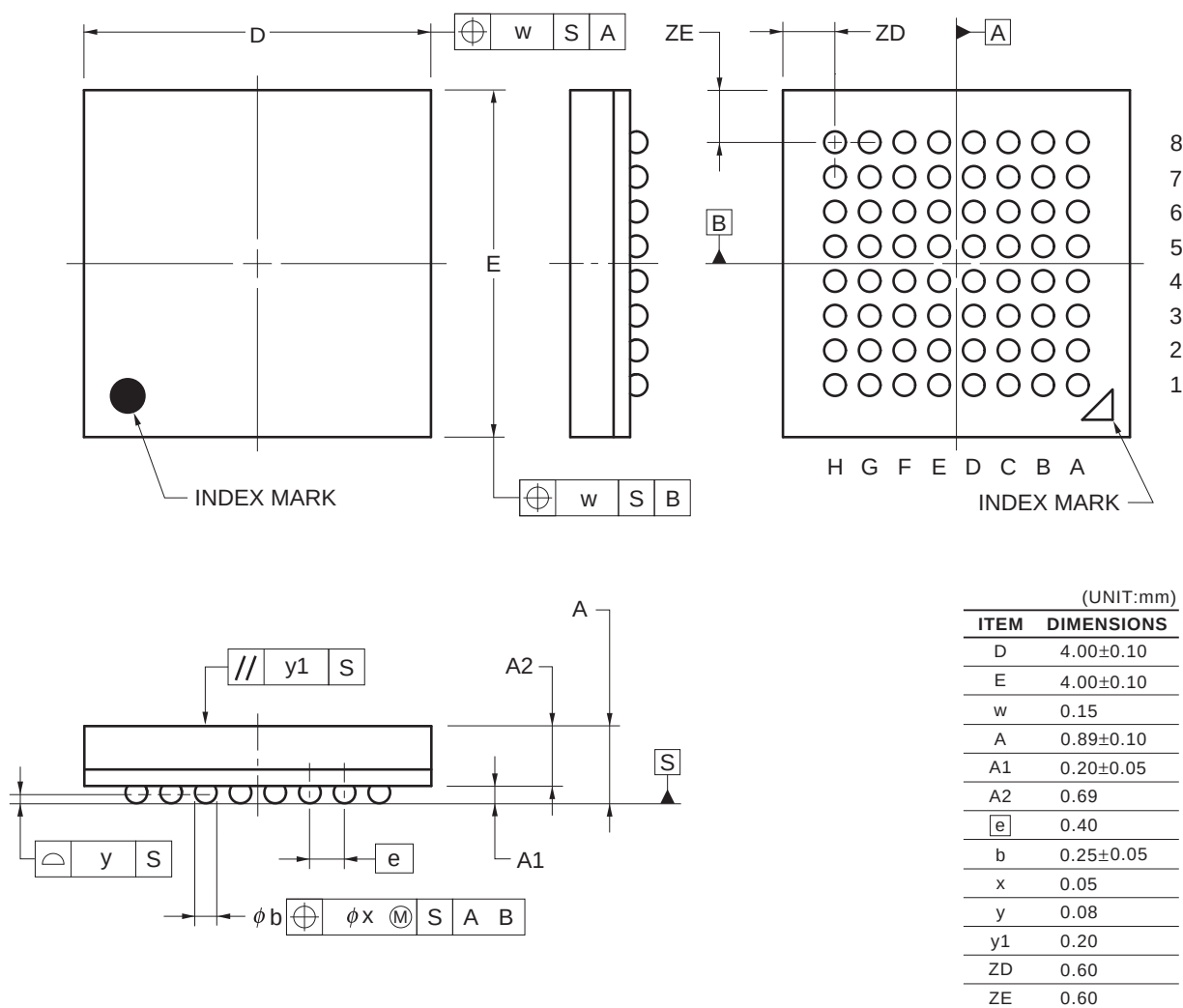
JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LFQFP64-10x10-0.50	PLQP0064KF-A	P64GB-50-UEU-2	0.35

**NOTE**

Each lead centerline is located within 0.08 mm of its true position at maximum material condition.

R5F10ELCABG, R5F10ELDABG, R5F10ELEABG

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-VFBGA64-4x4-0.40	PVBG0064LA-A	P64F1-40-AA2-2	0.03



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